1N914WS

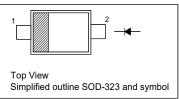
Silicon Epitaxial Planar Switching Diode

Features

- High reliability
- Small plastic package suitable for surface mounted design

PINNING

PIN	DESCRIPTION		
1	Cathode		
2	Anode		



Applications

• High speed switching

Absolute Maximum Ratings (T_a = 25°C)

Parameter		Symbol	Value	Unit
Repetitive Reverse Voltage		V_{RRM}	100	V
Average Rectified Forward Current		I _{F(AV)}	200	mA
Non-repetitive Peak Forward Surge Current	at t = 1 s at t = 1 µs	I _{FSM}	1 2	А
Power Dissipation		P_D	200	mW
Junction Temperature		Tj	150	°C
Storage Temperature Range		T_{stg}	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient 1)	$R_{\theta JA}$	625	°C/W

¹⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



1N914WS

Characteristics at T_a = 25℃

Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at I _F = 10 mA	V _F	1	1	V
Reverse Breakdown Voltage at $I_R = 5 \mu A$ at $I_R = 100 \mu A$	$V_{(BR)R}$	75 100		V V
Reverse Current at V_R = 20 V at V_R = 75 V at V_R = 20 V, T_j = 150 °C	I _R	- - -	25 5 50	nΑ μΑ μΑ
Total Capacitance at $V_R = 0 V$, $f = 1 MHz$	C _{tot}	-	4	pF
Reverse Recovery Time at $I_F = 10$ mA, $I_{rr} = 0.1 \times I_R$, $V_R = 6$ V, $R_L = 100$ Ω	t _{rr}	-	4	ns



Electrical Characteristics Curves

Fig 1. Power Derating Curve

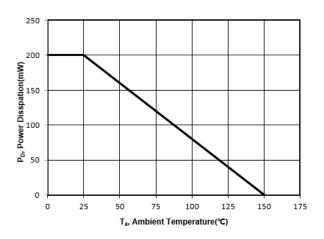


Fig 2. Capacitance characteristics

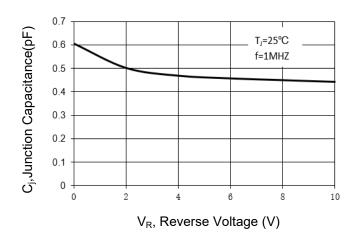


Fig 3. Reverse Characteristics

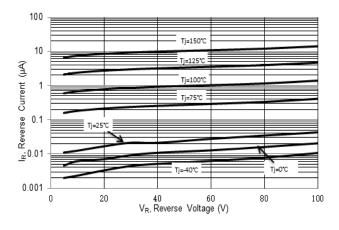
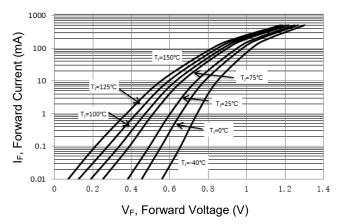


Fig 4. Forward Characteristics

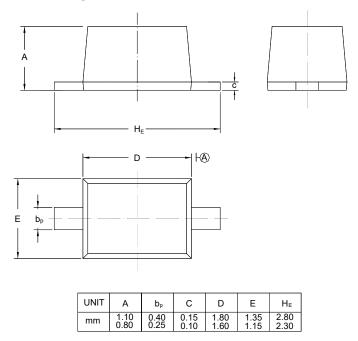




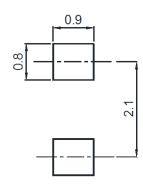
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-323



Recommended Soldering Footprint



Packing information

Dookege	Tape Width	Pit	Pitch		Size	Der Deel Deeking Quantity	
Package	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
SOD-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

Marking information

" W2 " = Part No.

" III " = Cathode line

Font type: Arial



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